# DTB543E series

-500mA/-12V Low V<sub>CE(sat)</sub> Digital transistor (with built-in resistor)

•Outline

(3)

DTB543EM (VMT3) (3)

DTB543EE

(EMT3)

Parameter	Value
V <sub>CC</sub>	-12V
I <sub>C(MAX.)</sub>	-500mA
R <sub>1</sub>	4.7kΩ
R <sub>2</sub>	4.7kΩ

### Features

1)V<sub>CE(sat)</sub> is lower than conventional products.

- 2)Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see equivalent circuit).
- 3)The bias resistors consist of thin-film resistors with complete isolation to allow positive biasing of the input. They also have the advantage.

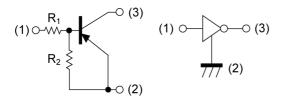
of almost completely eliminating parasitic effects.

## Application

INVERTER, INTERFACE, DRIVER

# Inner circuit

### DTB543EM

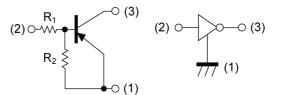


(1) IN (BASE) (2) GND (+) (EMITTER) (3) OUT (COLLECTOR)

### Packaging specifications

SOT-416

## DTB543EE



(1) GND (+) (EMITTER)(2) IN (BASE)(3) OUT (COLLECTOR)

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTB543EM	SOT-723 (VMT3)	1212	T2L	180	8	8000	X13
DTB543EE	SOT-416 (EMT3)	1616	TL	180	8	3000	X13

# • Absolute maximum ratings ( $T_a = 25^{\circ}C$ )

Parameter			Values	Unit
Supply voltage		V <sub>cc</sub>	-12	V
Input voltage		V <sub>IN</sub>	-12 to 10	V
Collector current		I <sub>C(MAX)</sub> *1	-500	mA
	DTB543EM	D *2	150	
Power dissipation	DTB543EE	P <sub>D</sub> *2	150	— mW
Junction temperature		Tj	150	°C
Range of storage temperature		T <sub>stg</sub>	-55 to +150	°C

# •Electrical characteristics (T<sub>a</sub> = 25°C)

Deremeter	Cump of	Conditions	Values			Linit	
Parameter	Parameter Symbol Conditions		Min.	Тур.	Max.	Unit	
Inputvoltogo	V <sub>I(off)</sub>	V <sub>CC</sub> = -5V, I <sub>O</sub> = -100µA	-5V, I <sub>O</sub> = -100μA0		-0.5	V	
Input voltage	V <sub>I(on)</sub>	V <sub>O</sub> = -0.3V, I <sub>O</sub> = -20mA	-2.5	-	-	v	
Output voltage	V <sub>O(on)</sub>	I <sub>O</sub> = -100mA, I <sub>I</sub> = -5mA	-	-60	-300	mV	
Input current	I <sub>I</sub>	I <sub>1</sub> V <sub>1</sub> = -5V		-	-1.4	mA	
Output current	I <sub>O(off)</sub>	V <sub>CC</sub> = -12V, V <sub>I</sub> = 0V	-	-	-500	nA	
DC current gain $G_1 = V_0 = -2V_1$		V <sub>O</sub> = -2V, I <sub>O</sub> = -100mA	115	-	-	-	
Input resistance	R <sub>1</sub>	-	3.29	4.7	6.11	kΩ	
Resistance ratio	$R_2/R_1$	-	0.8	1.0	1.2	-	
Transition frequency $f_T^{*1}$ $V_{CE} = -10V, I_E = 5m$ f = 100MHz		V <sub>CE</sub> = -10V, I <sub>E</sub> = 5mA, f = 100MHz	-	260	-	MHz	

\*1 Characteristics of built-in transistor

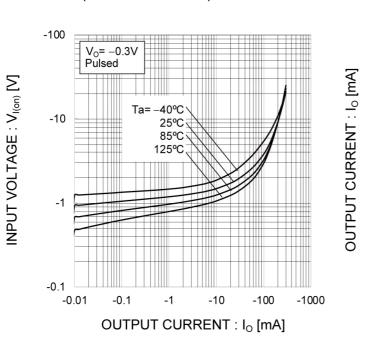
\*2 Each terminal mounted on a reference land.



# •Electrical characteristic curves (T<sub>a</sub> =25°C)

(ON Characteristics)

Fig.1 Input Voltage vs. Output Current



# Fig.2 Output Current vs. Input Voltage (OFF Characteristics)

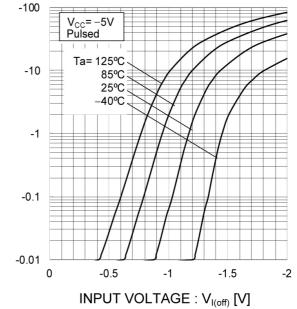


Fig.3 Output Current vs. Output Voltage

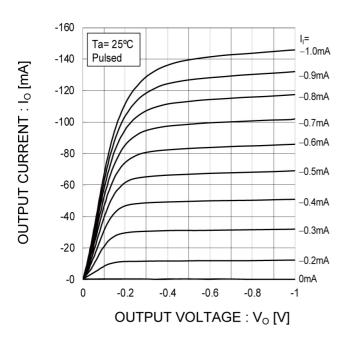
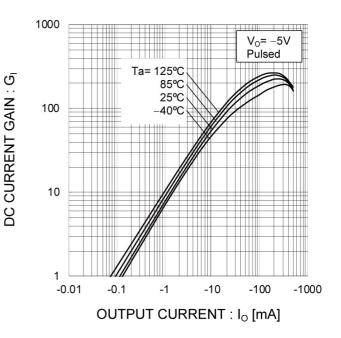
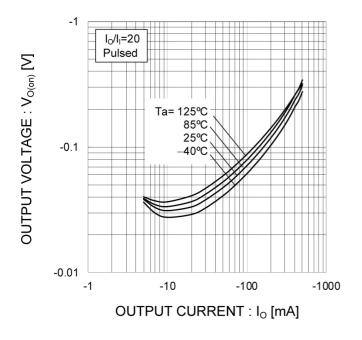


Fig.4 DC Current Gain vs. Output Current





# •Electrical characteristic curves (T<sub>a</sub> =25°C)



# Fig.5 Output Voltage vs. Output Current



# Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
A	0.45	0.55	0.018	0.022	
A1	0.00	0.10	0.000	0.004	
b	0.17	0.27	0.007	0.011	
b1	0.27	0.37	0.011	0.015	
с	0.08	0.18	0.003	0.007	
D	1.10	1.30	0.043	0.051	
E	0.70	0.90	0.028	0.035	
е	0.40		0.02		
HE	1.10	1.30	0.043	0.051	
L	0.10	0.30	0.004	0.012	
Lp	0.20	0.40	0.008	0.016	
x	-	0.10	-	0.004	
DIM	MILIM	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
b2	-	0.37	-	0.015	
b3	_	0.47		0.019	
e1	0.	80	0.031		
1	-	0.50	-	0.020	

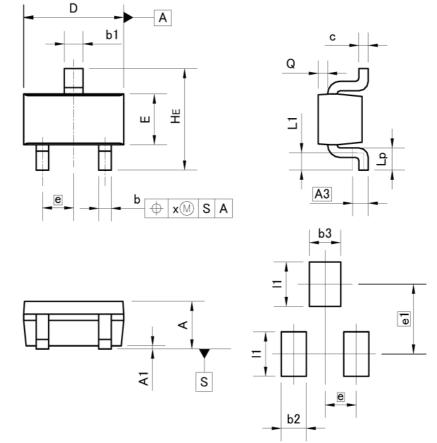
Dimension in mm/inches



### Dimensions



# (EMT3)



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	0.60	0.80	0.024	0.031	
A1	0.00	0.10	0.000	0.004	
A3	0.	25	0.0	10	
b	0.15	0.30	0.006	0.012	
b1	0.25	0.40	0.010	0.016	
с	0.10	0.20	0.004	0.008	
D	1.50	1.70	0.059	0.067	
E	0.70	0.90	0.028	0.035	
е	0.	50	0.020		
HE	1.40	1.80	0.055	0.071	
L1	0.10	-	0.004	-	
Lp	0.15	-	0.006	2	
Q	0.05	0.25	0.002	0.010	
х	-	0.10	-	0.004	

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	1	0.40	-	0.016
b3	-	0.50	-	0.020
e1	1.10		0.0	43
1	2. <del></del>	0.70	-	0.028

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Applications
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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	
CLASSⅣ	CLASSII	CLASSⅢ	CLASSII

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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [C] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
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- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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